

TPS6282xEVM-794 Evaluation Module

The TPS6282xEVM-794 facilitates the evaluation of the TPS62825 and TPS62826 2-A and 3-A pin-to-pin compatible step-down converters with DCS-Control in a 1.5-mm \times 1.5-mm QFN package. The PWR794-001 uses the 2-A TPS62825, and the PWR794-002 uses the 3-A TPS62826. The EVMs output a 1.8-V output voltage with 1% accuracy from input voltages from 2.4 V to 5.5 V with a maximum solution height of 1 mm. The TPS62825 and TPS62826 are highly efficient and small solutions for point-of-load (POL) converters in all types of equipment, such as solid-state drives (SSDs), optical modules, and portable devices.

Contents

	Contents	
1	Introduction	2
2	Setup	3
3	TPS6282xEVM-794 Test Results	
4	Board Layout	5
5	Schematic and Bill of Materials	
	List of Figures	
1	Thermal Performance ($V_{IN} = 5 \text{ V}, I_{OUT} = 3 \text{ A}$)	4
2	Loop Response Measurement (V _{IN} = 5 V, Load = 3 A)	4
3	Top Assembly	5
4	Top Layer	5
5	Signal Layer 1	5
6	Signal Layer 2	
7	Bottom Layer	6
8	TPS6282xEVM-794 Schematic	7
	List of Tables	
1	Performance Specification Summary	2
2	TPS6282xEVM-794 Bill of Materials	8



Introduction www.ti.com

1 Introduction

The TPS62825 and TPS62826 are synchronous, step-down converters in a small 1.5- × 1.5- × 1-mm QFN package. Two different devices in this family support 2 A or 3 A of output current.

1.1 Performance Specification

Table 1 provides a summary of the TPS6282xEVM-794 performance specifications.

Table 1. Performance Specification Summary

Specification	Test Conditions	Min	Тур	Max	Unit
Input voltage		2.4	5	5.5	V
Output voltage setpoint			1.8		V
Output current	TPS62825EVM-794	0		2	Α
	TPS62826EVM-794	0		3	Α

1.2 Modifications

The printed-circuit board (PCB) for this EVM is designed to accommodate both the fixed and adjustable output voltage versions of this integrated circuit (IC). Additional input and output capacitors can also be added. Finally, the loop response of the IC can be measured.

1.2.1 Fixed Output Voltage Operation

U1 can be replaced with the fixed output voltage version of the IC for evaluation. For fixed output voltage version operation, replace R1 with a $0-\Omega$ resistor and remove R2 and C3.

1.2.2 Input and Output Capacitors

C7 is provided for an additional input capacitor. This capacitor is not required for proper operation but can be used to reduce the input voltage ripple.

C5 and C8 are provided for additional output capacitors. These capacitors are not required for proper operation but can be used to reduce the output voltage ripple and to improve the load transient response. The total output capacitance must remain within the recommended range in the data sheet for proper operation.

1.2.3 Loop Response Measurement

The loop response of the TPS6282xEVM-794 can be measured by lifting both R1 and C3 and inserting a $50-\Omega$ resistor in series with these two components to inject the measurement signal across. The results of this test are shown in Figure 2.



www.ti.com Setup

2 Setup

This section describes how to properly use the TPS6282xEVM-794.

2.1 Input/Output Connector Descriptions

J1, Pin 1 and 2 – VIN	Positive input connection from the input supply for the EVM.
J1, Pin 3 and 4 - S+/S-	Input voltage sense connections. Measure the input voltage at this point.
J1, Pin 5 and 6 – GND	Input return connection from the input supply for the EVM.
J2, Pin 1 and 2 – VOUT	Output voltage connection
J2, Pin 3 and 4 - S+/S-	Output voltage sense connections. Measure the output voltage at this point.
J2, Pin 5 and 6 – GND	Output return connection
J3 – PG/GND	The PG output appears on pin 1 of this header with ground on pin 2.
JP1 – EN	EN pin input jumper. Place the supplied jumper across ON and EN to turn on the IC. Place the jumper across OFF and EN to turn off the IC.
JP2 – PG Pullup Voltage	PG pin pullup voltage jumper. Place the supplied jumper on JP3 to connect the PG pin pullup resistor to V_{IN} . Alternatively, the jumper can be removed and a different voltage can be supplied on pin 2 to pull up the PG pin to a different level. This externally applied voltage must remain below 6 V.

2.2 Setup

To operate the EVM, set jumpers JP1 through JP2 to the desired position per Section 2.1. Connect the input supply to J1 and connect the load to J2.



3 TPS6282xEVM-794 Test Results

The TPS6282xEVM-794 was used to take all the data in *TPS6282x*, *2-*, *3-A Step-Down Converter with 1% Output Accuracy in 1.5-mm* × *1.5-mm QFN Package*. See the device data sheet for the performance of this EVM.

Figure 1 shows the thermal performance of the EVM.

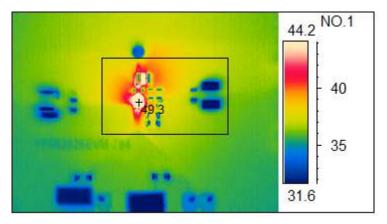


Figure 1. Thermal Performance ($V_{IN} = 5 \text{ V}, I_{OUT} = 3 \text{ A}$)

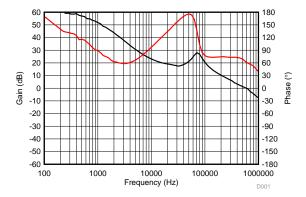


Figure 2. Loop Response Measurement ($V_{IN} = 5 \text{ V}$, Load = 3 A)



www.ti.com Board Layout

4 Board Layout

This section provides the TPS6282xEVM-794 board layout and illustrations in Figure 3 through Figure 7. The Gerbers are available on the EVM product page: TPS62825EVM-794.

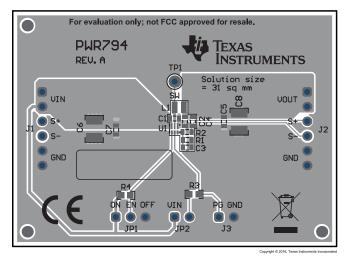


Figure 3. Top Assembly

Figure 4. Top Layer

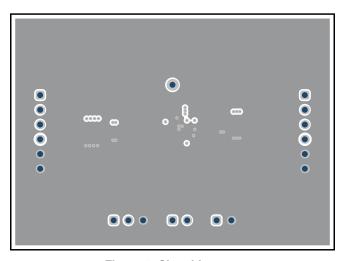


Figure 5. Signal Layer 1

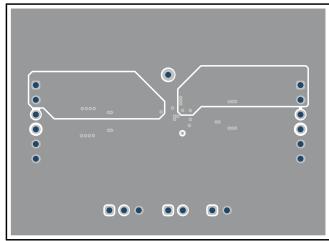


Figure 6. Signal Layer 2



Board Layout www.ti.com

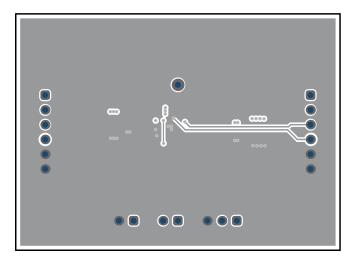


Figure 7. Bottom Layer



www.ti.com Schematic and Bill of Materials

5 Schematic and Bill of Materials

This section provides the TPS6282xEVM-794 schematic and bill of materials (BOM).

5.1 Schematic

Figure 8 illustrates the EVM schematic.

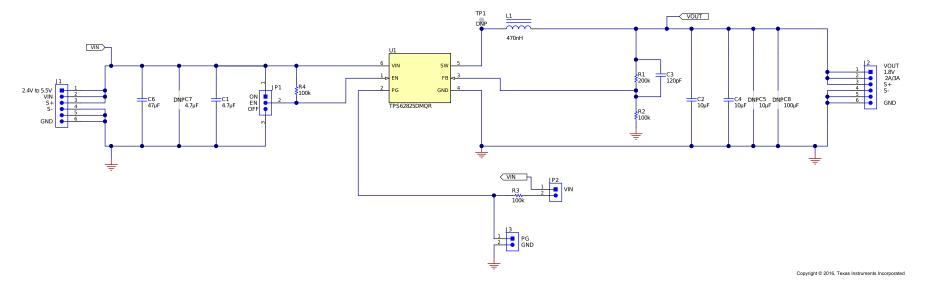


Figure 8. TPS6282xEVM-794 Schematic



Schematic and Bill of Materials www.ti.com

5.2 Bill of Materials

Table 2 lists the BOM for this EVM.

Table 2. TPS6282xEVM-794 Bill of Materials

Count		Designator Value		Description	Package	Part Number	Manufacturer
-001	-002	Designator	Ji value	Description	Reference	Part Number	Manufacturer
1	1	C1	4.7μF	CAP, CERM, 4.7 μF, 6.3 V, ±10%, X7R, 0603	0603	JMK107BB7475MA-T	Taiyo Yuden
2	2	C2, C4	10μF	CAP, CERM, 10 μF, 10 V, ±20%, X7R, 0603	0603	GRM188Z71A106MA73D	Murata
1	1	C3	120pF	CAP, CERM, 120 pF, 50 V, ±5%, C0G/NP0, 0603	0603	Std	Std
1	1	C6	47μF	CAP, CERM, 47 μF, 10 V, ±20%, X7R, 1210	1210	GRM32ER71A476ME15L	Murata
1	1	L1	470nH	Inductor, Shielded, 470 nH, 3.6 A, 0.032 ohm, SMD	2016	DFE201610E-R47M=P2	Murata
1	1	R1	200k	RES, 200 k, 1%, 0.1 W, 0603	0603	Std	Std
3	3	R2, R3, R4	100k	RES, 100 k, 1%, 0.1 W, 0603	0603	Std	Std
1	0	U1		2-A Step-Down Converter with 1% Output Accuracy in 1.5-mm × 1.5-mm QFN	1.5x1.5mm	TPS62825DMQ	Texas Instruments
0	1	U1		3-A Step-Down Converter with 1% Output Accuracy in 1.5-mm × 1.5-mm QFN	1.5x1.5mm	TPS62826DMQ	Texas Instruments

IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ('TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products http://www.ti.com/sc/docs/stdterms.htm), evaluation modules, and samples (http://www.ti.com/sc/docs/sampterms.htm).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2018, Texas Instruments Incorporated